IN THE CLAIMS

Please enter the pending claims as follows:

1	1. (Previously Presented) A broad-angle multilayer (ML) mirror
2	comprising a multiple layer structure to provide uniform reflectivity over a wide
3	range of incident angles with small phase shifts, the structure comprising 36 bi-
4	layers wherein Molybdenum has a thickness of 2.4 – 11.3 nm and Silicon has a
5	thickness of 3.5 – 10.4 nm.
6	
1	2. (Original) The ML mirror of claim 1 wherein the ML mirror provides
2	an acceptance angle in excess of 20° without a significant loss of reflectivity.
3	
1	3. (Original) The ML mirror of claim 2 wherein the loss of reflectivity is
2	approximately 17%.
3	
1	4. (Original) The ML mirror of claim 1 wherein the ML mirror increases
2	the relative phase shift.
3	
4	

5. (Original) The ML mirror of claim 1 wherein the ML mirror comprises 1 a 13.5nm central wavelength. 2 3 6. (Previously Presented) The ML mirror of claim 1 wherein the structure 1 comprises: a 13.5nm central wavelength. 2 3 7. (Previously Presented) The ML mirror of claim 1 wherein the bi-layers 1 in the structure have a variable thickness. 2 3 The ML mirror of claim 1 wherein the structure 8. (Previously Presented) 1 2 includes additional bi-layers. 3 9. (Previously Presented) 1 The ML mirror of claim 8 wherein the additional bi-layers in the structure are comprised of Mo/Si bi-layers. 2 3 10. (Previously Presented) The ML mirror of claim 8 wherein the 1 additional bi-layers in the structure have a variable thickness. 2 3 11. 1 (Previously Presented) An optical system having an extreme ultraviolet (EUV) radiation source, the system comprising: 2 a mask; 3 a wafer; and 4

a plurality of reflecting surfaces for imaging the mask on the wafer, 5 wherein one or more of the plurality of reflecting surfaces includes a broad-angle 6 7 multilayer (ML) mirror having a multiple layer structure to provide uniform reflectivity over a wide range of angles with small phase shifts, the ML mirror 8 9 comprising 36 bi-layers wherein Molybdenum has a thickness of 2.4 – 11.3 nm and Silicon has a thickness of 3.5 – 10.4 nm. 10 11 12. 1 (Original) The system of claim 11 wherein the plurality of reflecting surfaces comprises six mirrors. 2 3 1 13. (Original) The system of claim 11 wherein the ML mirror provides an acceptance angle in excess of 20° without a significant loss of reflectivity. 2 3 14. (Original) The system of claim 13 wherein the ML mirror has a loss of 1 2 reflectivity of approximately 17%. 3 15. 1 (Original) The system of claim 11 wherein the ML mirror increases the 2 relative phase shift. 3 1 16. (Original) The system of claim 11 wherein the ML mirror comprises a 2 13.5 nm central wavelength. 3

17. (Previously Presented) The system of claim 11 wherein the structure 1 comprises: a 13.5nm central wavelength. 2 3 18. (Previously Presented) The system of claim 11 wherein the bi-layers 1 have a variable thickness. 2 3 19. (Previously Presented) The system of claim 11 wherein the structure 1 includes more than thirty-six bi-layers. 2 3 20. (Previously Presented) 1 An optical system having an extreme ultra-2 violet (EUV) radiation source, the system comprising: a mask; 3 a wafer; and 4 a plurality of reflecting surfaces for imaging the mask on the wafer, 5 including: a mirror having a multiple layer structure to provide uniform 6 reflectivity over a wide range of angles with small phase shifts, the mirror 7 8 comprising 36 bi-layers wherein Molybdenum has a thickness of 2.4 - 3.7 nm except for a thicker bi-layer 1 nearest substrate and Silicon has a thickness of 3.5 -9 4.1 nm except for thicker bi-layers 3, 5, and 15. 10 11 12 21. (Previously Presented) The system of claim 20 wherein the mirror 1 provides an acceptance angle in excess of 20° without a significant loss of 2 reflectivity. 3 Application Serial No.: 10/811,607 Attorney's Docket No. 42P19028

- 1 22. (Previously Presented) The system of claim 21 wherein the mirror has
- 2 a loss of reflectivity of approximately 17%.

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- 1 23. (Previously Presented) The system of claim 20 wherein the mirror
- 2 comprises a 13.5nm central wavelength.

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- 1 24. (Previously Presented) The system of claim 20 wherein the structure
- 2 comprises: a 13.5nm central wavelength.

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- 1 25. (Previously Presented) The system of claim 20 wherein the bi-layers
- 2 have a variable thickness.

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- 1 26. (Previously Presented) The system of claim 20 wherein the structure
- 2 includes more than thirty-six bi-layers.